

SMD5050(1000~3600V)

Description

SMD5050 Gas Discharge Tubes (GDT) series provides high levels of protection against fast rising transients caused by lightning disturbances. Offered in a miniature surface mount package, it has a surge rating of 3KA 8/20µs.

SMD5050 GDTs are high voltage (1000-3600V) components designed for surge protection and high isolation applications. It is also suitable for applications for which bias voltage or signal levels of several hundred volts are normally present. SMD5050 GDTs can be used in conjunction with MOVs (Metal Oxide Varistors) to provide superior protection performance for AC applications.



Electrical symbol



Features

- Voltage Ranges 1000V to 3600V
- I Excellent response to fast rising transients
- I 8/20µs Impulse current capability: 3KA
- I Non-Radioactive
- I Ultra Low capacitance (<0.8pF)
- I Size: 4.2mm*5mm*5mm
- I Storage and operational temperature: -40~+125°C

Applications

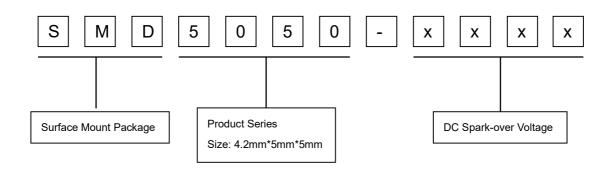
Automotive:

- I On-board chargers
- I Vehicle charging stations

Others:

- I LED lighting
- Power supply
- I Photovoltaic
- I Air conditioning

Part Number Code





SMD5050(1000~3600V)

Electrical Characteristics

	DC Spark-over Voltage ^{1) 2)} @100V/S	Impulse Spark-over Voltage		Insulation Resistance	Capacitance @1MHz	Glow Voltage @10mA		AC withstand	Life Ratings		
Part Number									Impulse Discharge Current		Discharge
		100V/μS	1KV/μS			@ · • · · · · ·		voltage @5mA 1Min	@8/20µS		Current @50Hz 1S
		Max	Max	Min	Max	Typical	Typical		±5 times	1 time	5 times
	v	V	V	GΩ	pF	V	V	v	KA	KA	Α
SMD5050-1000	1000±20%	1500	1600	1	0.8	160	15	500	3	5	3
SMD5050-1200	1200±20%	1700	1800	1	0.8	160	15	600	3	5	3
SMD5050-1500	1500±20%	2300	2500	1	0.8	235	15	750	3	5	3
SMD5050-2000	2000±20%	3300	3500	1	0.8	260	20	1000	3	5	3
SMD5050-2500	2500±20%	3800	4000	1	0.8	260	20	1300	3	5	3
SMD5050-2700	2300~3240	4000	4200	1	0.8	260	20	1500	3	5	3
SMD5050-3000	3000±20%	4300	4500	1	0.8	260	20	1600	3	5	3
SMD5050-3600	3600±20%	4800	5000	1	0.8	260	20	1900	3	5	3
Glow to Arc transiti	Glow to Arc transition Current				~0.3A						
Weight					~0.42g						
Operation and storage temperature				-40~+125°C							
Climatic category (IEC 60068-1)					40/125/21						
Marking				Without							
Surface treatment					Matte-tin plate	ed					

¹⁾ At delivery AQL 0.65 level II, DIN ISO 2859.

Terms in accordance with ITU-T Rec. K.12, IEC 61643-311, GB/T 18802.311.

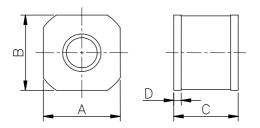
²⁾ In ionized mode.

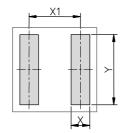
³⁾ Insulation Resistance Measuring Voltage at DC 100V.



SMD5050(1000~3600V)

Dimensions



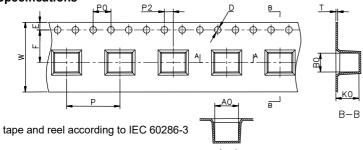


Recommended Soldering Pad Layout

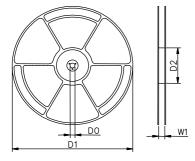
Symbol	Millimeters	Inches		
Α	5.0±0.2	0.197±0.008		
В	5.0±0.2	0.197±0.008		
С	4.2±0.3	0.165±0.012		
D	0.5±0.1	0.020±0.004		
x	1.2	0.047		
X1	4.0	0.165		
Y	5.5	0.217		

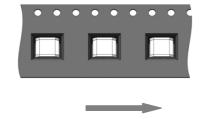
Packaging Information

Tape Specifications



Reel Specifications





Direction of Unreeling

Symbol	Millimeters	Inches
w	16±0.3	0.630±0.012
Α0	5.3±0.1	0.209±0.004
В0	4.3±0.1	0.17±0.004
K0	5.2±0.1	0.205±0.004
Р	12±0.1	0.472±0.004
F	7.5±0.1	0.295±0.004
E	1.75±0.1	0.069±0.004
D	1.5+0.1/-0.0	0.059+0.004/-0.0
P0	4±0.1	0.157±0.004
P2	2±0.1	0.079±0.004
Т	0.4±0.1	0.016±0.004
D0	13.3±0.15	0.524±0.006
D1	330±2	12.992±0.079
D2	100+1/-2	3.937+0.039/-0.079
W1	16.5±0.4	0.65±0.016



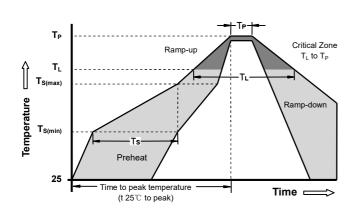
SMD5050(1000~3600V)

	Reel	Inner Box	Carton		
Size	330×17mm	340×333×70mm	375×353×380mm		
Quantity	MPQ/MOQ: 1 reel=1,000pcs	1 Inner Box=3 reels=3,000pcs	1Carton=5 Inner boxes=15,000pcs		
Photos		PALM SENT AND MANAGEMENT OF THE PARK AND	RUILERN INCOME. 260-19-25-1-4 Commence Cope Real Property Cope		

Version: A2/2024-01-18

File Number: SP-GDT-033

Soldering Parameters - Reflow Soldering (Surface Mount Devices)



Reflow Condit	ion	Pb - Free assembly		
	-Temperature Min (T _{s(min)})	150°C		
Preheat	-Temperature Max (T _{s(max)})	200°C		
	- Time (min to max) (t _s)	60 -180 Seconds		
Average ramp to peak	up rate (Liquids Temp T _L)	3°C/second max		
T _{S(max)} to TL - F	Ramp-up Rate	5°C/second max		
Reflow	- Temperature (T _L) (Liquids)	217°C		
	- Time (min to max) (t _s)	60 -150 Seconds		
Peak Tempera	iture (T _P)	260 +0/-5°C		
Time within 5° Temperature (C of actual peak t _p)	10 - 30 Seconds		
Ramp-down R	ate	6°C/second max		
Time 25°C to p	peak Temperature (T _P)	8 minutes Max		
Do not exceed		260°C		





SMD5050(1000~3600V)

Terms and definitions

NO.	Item	Definitions			
1	Gas discharge tube(GDT)	A gap, or several gaps, in an enclosed discharge medium, other than air at atmospheric pressure,			
		designed to protect apparatus or personnel, or both, from high transient voltages. Also referred to as "gas tube surge arrester".			
2	DC Spark-over Voltage	The voltage at which the gas discharge tube sparks over with slowly increasing d.c. voltage.			
3	Impulse Spark-over	The highest voltage which appears across the terminals of a gas discharge tube in the period between			
	Voltage	the application of an impulse of given wave-shape and the time when current begins to flow.			
5	Arc voltage	Voltage drop across the GDT during arc current flow.			
6	Glow voltage	voltage Peak value of voltage drop across the GDT when a glow current is flowing.			
	Impulse discharge				
7	current 8/20µs	Current impulse with a nominal virtual front time of 8 μs and a nominal time to half-value of 20 μs.			
8	Alternating Discharge Current	The rms value of an approximately sinusoidal alternating current passing through the gas discharge			
		tube.			
9	Insulation Resistance	Insulation resistance shall be measured from each terminal to every other terminal of the GDT. The test			
9		is performed with DC50V when normal spark-over Voltage 70~150V, others with DC100V.			
10	Capacitance	The capacitance shall be measured once at 1 MHz between all terminals unless otherwise specified.			

Version: A2/2024-01-18

File Number: SP-GDT-033